MOSFET – Power, Dual, N-Channel, WDFN 2X2 mm 30 V, 4.6 A

Features

- WDFN Package Provides Exposed Drain Pad for Excellent Thermal Conduction
- 2x2 mm Footprint Same as SC-88
- Lowest R_{DS(on)} Solution in 2x2 mm Package
- 1.5 V R_{DS(on)} Rating for Operation at Low Voltage Gate Drive Logic Level
- Low Profile (< 0.8 mm) for Easy Fit in Thin Environments
- This is a Pb–Free Device

Applications

- DC-DC Converters (Buck and Boost Circuits)
- Low Side Load Switch
- Optimized for Battery and Load Management Applications in Portable Equipment such as, Cell Phones, PDA's, Media Players, etc.
- Level Shift for High Side Load Switch

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	30	V
Gate-to-Source Voltage			V _{GS}	±8.0	V
Continuous Drain	Steady State	$T_A = 25^{\circ}C$	I _D	3.7	А
Current (Note 1)		T _A = 85°C		2.7	
	t ≤ 5 s	$T_A = 25^{\circ}C$		4.6	
Power Dissipation (Note 1)	Steady State T _A = 25°C		PD	1.5	W
	t ≤ 5 s	<u>^</u>		2.3	
Continuous Drain		$T_A = 25^{\circ}C$	I _D	2.5	А
Current (Note 2)	Steady	T _A = 85°C		1.8	
Power Dissipation (Note 2)	State	$T_A = 25^{\circ}C$	PD	0.71	W
Pulsed Drain Current	t _p = 10 μs		I _{DM}	20	А
Operating Junction and Storage Temperature			T _J , T _{STG}	–55 to 150	°C
Source Current (Body Diode) (Note 2)			۱ _S	2.0	А
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

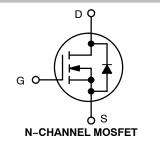
- 1. Surface Mounted on FR4 Board using 1 in sq pad size (Cu area = 1.127 in sq [2 oz] including traces).
- Surface Mounted on FR4 Board using the minimum recommended pad size of 30 mm², 2 oz Cu.



ON Semiconductor®

http://onsemi.com

V _{(BR)DSS}	R _{DS(on)} MAX	ID MAX (Note 1)
	70 mΩ @ 4.5 V	
30 V	90 mΩ @ 2.5 V	4.6 A
	125 mΩ @ 1.8 V	
	250 mΩ @ 1.5 V	

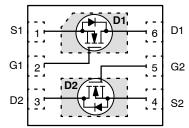






(Note: Microdot may be in either location)

PIN CONNECTIONS



(Top View)

ORDERING INFORMATION

Device	Package	Shipping [†]
NTLJD4116NT1G	WDFN6 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL RESISTANCE RATINGS

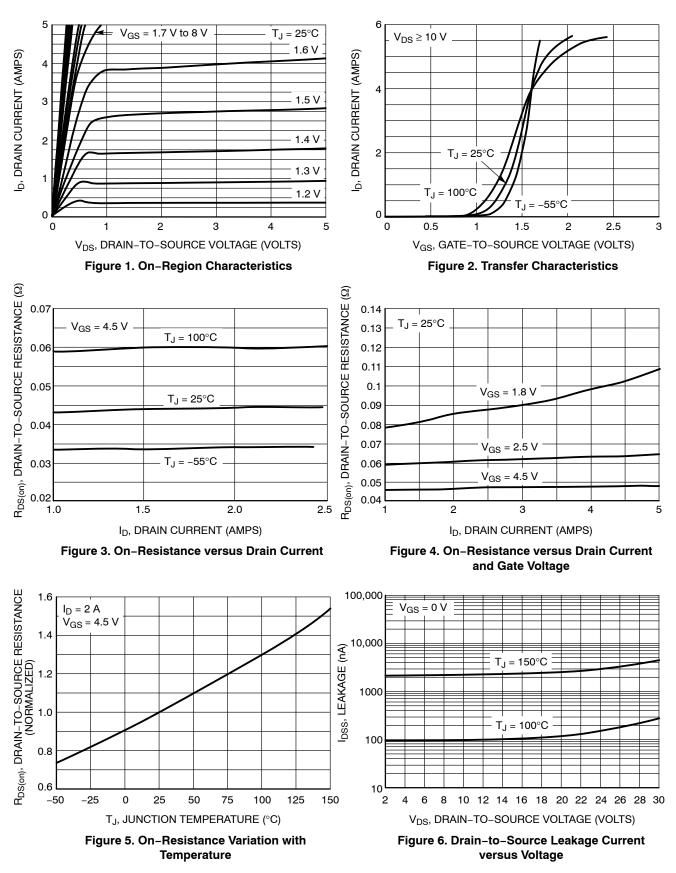
Parameter	Symbol	Мах	Unit	
SINGLE OPERATION (SELF-HEATED)				
Junction-to-Ambient - Steady State (Note 3)	$R_{ heta JA}$	83		
Junction-to-Ambient - Steady State Min Pad (Note 4)	$R_{ heta JA}$	177	°C/W	
Junction-to-Ambient – t \leq 5 s (Note 3)	$R_{ hetaJA}$	54	1	
DUAL OPERATION (EQUALLY HEATED)				
Junction-to-Ambient - Steady State (Note 3)	$R_{ hetaJA}$	58		
Junction-to-Ambient - Steady State Min Pad (Note 4)	$R_{ heta JA}$	133	°C/W	
Junction-to-Ambient – t \leq 5 s (Note 3)	R _{θJA}	40		

Surface Mounted on FR4 Board using 1 in sq pad size (Cu area = 1.127 in sq [2 oz] including traces).
Surface Mounted on FR4 Board using the minimum recommended pad size (30 mm², 2 oz Cu).

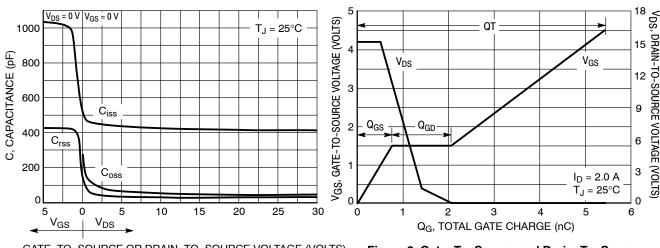
MOSFET ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Parameter	Symbol	Test Condition	ıs	Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 25	0 μA	30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	$I_D = 250 \ \mu A$, Ref to	25°C		18.1		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 24 V, V_{GS} = 0 V	T _J = 25°C T _J = 85°C			1.0 10	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm$	ů.			100	nA
ON CHARACTERISTICS (Note 5)	465	<u> </u>					
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = 25	50 µA	0.4	0.7	1.0	V
Negative Gate Threshold Temperature Coefficient	V _{GS(TH)} /T _J		pa (2.8		mV/°C
Drain-to-Source On-Resistance	R _{DS(on)}	V _{GS} = 4.5, I _D = 2.	.0 A		47	70	mΩ
		$V_{GS} = 2.5, I_D = 2.5$.0 A		56	90	1
		V _{GS} = 1.8, I _D = 1.	.8 A		88	125	1
		V _{GS} = 1.5, I _D = 1.	.5 A		133	250	
Forward Transconductance	9fs	V _{DS} = 5.0 V, I _D = 2	2.0 A		4.5		S
CHARGES, CAPACITANCES AND GA	TE RESISTANC	CE					
Input Capacitance	C _{ISS}	V_{GS} = 0 V, f = 1.0 MHz, V_{DS} = 15 V			427		pF
Output Capacitance	C _{OSS}				51		1
Reverse Transfer Capacitance	C _{RSS}				32		1
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 15 V, I_{D} = 2.0 A			5.4	6.5	nC
Threshold Gate Charge	Q _{G(TH)}				0.5		1
Gate-to-Source Charge	Q _{GS}				0.8		1
Gate-to-Drain Charge	Q _{GD}				1.24		1
Gate Resistance	R _G				0.37		Ω
SWITCHING CHARACTERISTICS (No	te 6)						
Turn-On Delay Time	t _{d(ON)}				4.8		ns
Rise Time	t _r	V _{GS} = 4.5 V, V _{DD} =	15 V,		11.8		1
Turn-Off Delay Time	t _{d(OFF)}	$I_{\rm D}$ = 2.0 A, $R_{\rm G}$ = 2.0 Ω			14.2		1
Fall Time	t _f				1.7		
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Recovery Voltage	Voltage V_{SD} $V_{CS} = 0 V IS = 2.0 A$ $T_J = 25^{\circ}C$	0.78	1.2	V			
		V_{GS} = 0 V, IS = 2.0 A	$T_{\rm J} = 125^{\circ}{\rm C}$ 0.62				
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, d _{ISD} /d _t = 100 A/µs, I _S = 2.0 A			10.5		
Charge Time	t _a				7.6		ns
Discharge Time	t _b				2.9		
Reverse Recovery Time	Q _{RR}				5.0		nC

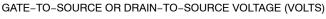
5. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
6. Switching characteristics are independent of operating junction temperatures.



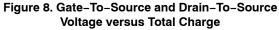
TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

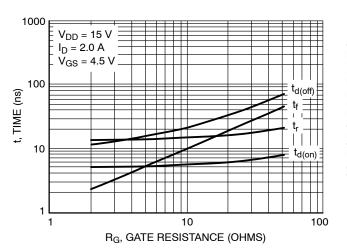


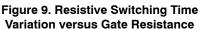
TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)











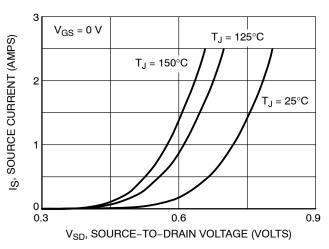
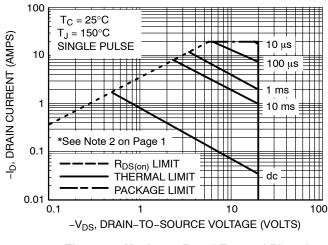
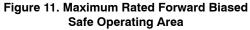
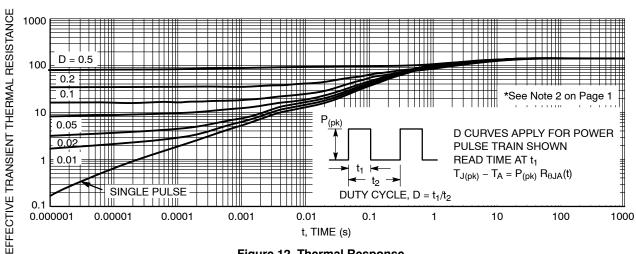


Figure 10. Diode Forward Voltage versus Current





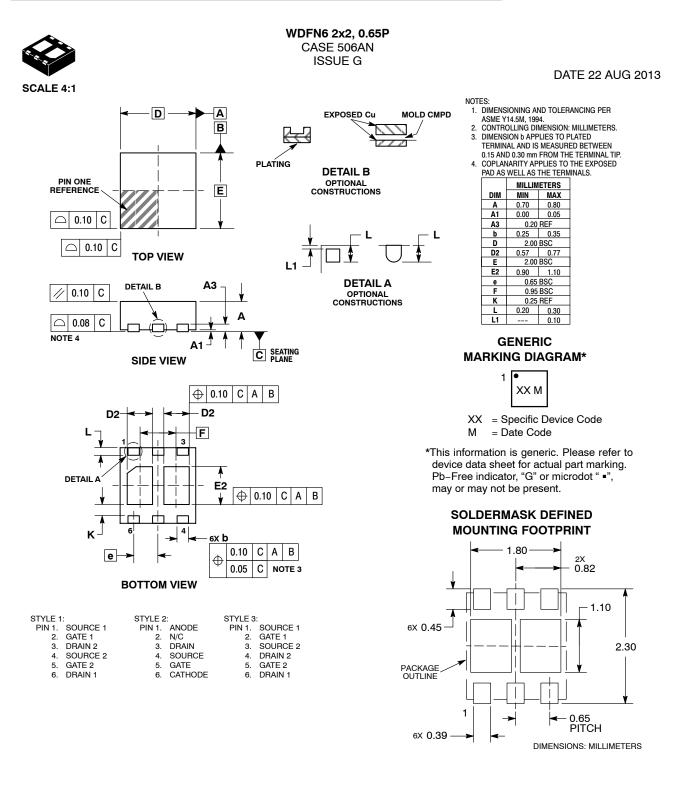


TYPICAL PERFORMANCE CURVES (T_J = 25° C unless otherwise noted)

Figure 12. Thermal Response

 μCool is a trademark of Semiconductor Components Industries, LLC (SCILLC).





DOCUMENT NUMBER:	98AON20861D	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.			
DESCRIPTION:	WDFN6 2X2, 0.65P		PAGE 1 OF 1		

ON Semiconductor and unarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights or the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcular performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below :

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE222 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UF0-7B